

## **Supplemental Application Data Sheet**

### **Application Information**

Application number::	Not Yet Assigned
Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	ASSEMBLIES HAVING STACKED SEMICONDUCTOR CHIPS AND METHODS OF MAKING SAME
Attorney Docket Number::	TESSERA 3.0-272
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	7
Total Drawing Sheets::	4
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

### **Applicant Information**

Applicant Authority Type::	Inventor
Primary Citizenship Country::	China
Status::	Full Capacity
Given Name::	Delin
Family Name::	Li
City of Residence::	San Jose
State or Province of Residence::	CA
Country of Residence::	US
Street of mailing address::	797 Firewood Court

City of mailing address:: San Jose  
State or Province of mailing address:: CA  
Country of mailing address:: US  
Postal or Zip Code of mailing address:: 95120

### **Correspondence Information**

Correspondence Customer Number:: 000530  
Phone number:: (908) 654-5000  
Fax number:: (908) 654-7866  
E-Mail address:: rgarguilo@ldlkm.com

### **Representative Information**

Representative Customer Number:: 000530

### **Domestic Priority Information**

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	Application claiming the benefit under 35 USC 119(e)	60/393,026	07/01/02

### **Assignee Information**

Assignee name:: Tessera, Inc.  
Street of mailing address:: 3099 Orchard Drive  
City of mailing address:: San Jose  
State or Province of mailing address:: CA  
Country of mailing address:: US  
Postal or Zip Code of mailing address:: 95134